

SPECIFICATION SHEET

SPECIFICATION SHEET NO.	Q0211- CR0603PB0RS001
DATE	Feb. 11, 2023
REVISION	A1
DESCRIPITION	Thick Film Chip Resistors, 0603 (1608 Metric), CR03 Series,
	Dimension L1.60*W0.80*H0.45mm, 2 Terminations
	Tolerance: Jumper, Resistance 20ohm, Dissipation Max. 1/10W @ 70°C
	Temperature Coefficient Rate (TCR): -200~+400ppm/°C
	Operating Temp. Range -55°C ~+155°C
	Package in Tape/Reel, 5,000pcs/Reel
	RoHS/RoHS III compliant and HF
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	Aillen CR03PB0R
PART CODE	CR0603PB0RS001

VENDOR APPROVE

Issued/Checked/Approved







DATE: Feb. 11, 2023

USTOMER APPROVE	
ATE:	



THICK FILM CHIP RESISTORS CR03 SERIES

DESCRIPTION







The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer. The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

MAIN FEATURE

- High Reliability And Stability
- Reduced Size Of Final Equipment
- Lower Assembly Costs
- Higher Component And Equipment Reliability
- RoHS III Compliant And Halogen Free Products

APPLICATION

- Consumer Electrical Equipment
- EDP, Computer Application
- Telecom Application

PART CODE GUIDE



CR	0603	Р	В	0R	S001
1	2	3	4	5	6

- 1) CR: Product code for Thick Film Chip Resistors
- 2) 0603: Size Code, 0603 (1608 Metric), CR03 Series, Dimensions L1.60*W0.80*H0.45mm
- 3) P: Resistance Range Tolerance Code, P: Jumper; B: +/-0.1%; D: +/-0.5%; F: +/-1%; J: +/-5%
- 4) B: Package Code, A: 4Kpcs/7"Reel; B:5kpcs/7"Reel; C:10kpcs/7"Reel; M:15kpcs/7"Reel; D:10kpcs/10"Reel; E:20kpcs/10"Reel
- 5) OR: Resistance value code. OR: Oohm; 1R2: 1.20hm; 15R: 150hm; 20R: 200hm; 39R: 390hm; 51R: 510hm; 240R: 2400hm;
- 390R: 390ohm; 1K: 1Kohm; 1K21: 1.21Kohm; 4K7: 4.7Kohm; 6K19: 6.19Kohm; 9K31: 9.31Kohm; 10K: 10Kohm;10K5: 10.5Kohm;
- 15K: 15 Kohm; 20K: 20Kohm; 100K: 100Kohm; 226K: 226Kohm; 1M: 1.0Mohm; 1M2: 1.2Mohm
- 6) S001: Internal control code, digits and letter; Blank: N/A



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DIMENSION (Unit: mm)

Image for reference



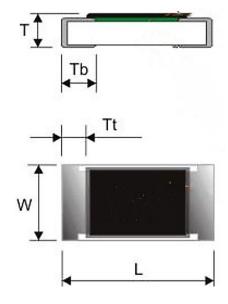
3-digits marking

General Marking:

*Each resistor is marked with
a three digits code on the
protective coating to designate

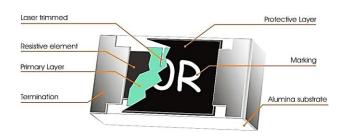
the nominal resistance value

CR03 series

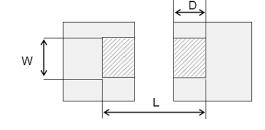


Item Dimension					
L	1.60±0.10				
W	0.80±0.10				
Т	0.45±0.15				
Тb	0.30±0.15				
Τt	0.30±0.10				

Resistors Construction For Reference



Recommended Solder Pad



Item Dimension				
W	0.70~0.90			
L	2.00~2.20			
D	0.80~1.00	3		



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GENERAL ELECTRONICAL CHARACTERISTICS

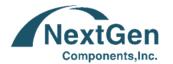
	Item	Unit	Symbol	Characteristic	Condition
Product Name			CR	Thick Film Chip Resistors	
	Size		0603	CR03 Series, L1.60*W0.80*H0.45mm	
Resis	stance Range	Ω		0	
Resista	ance Tolerance	%	Р	Jumper	
TCR	10MΩ≥ R>10Ω	ppm/°C		≤ ±100	
	R≤10Ω			-200~+400	1
Max	. Dissipation	W		1/10	@ Tamb=70°C
Operation	ng Temperature	°C		-55 ~+155	
Max. Op	eration Voltage	V		75	@DC or RMS
Max. Ov	Max. Overload Voltage			150	@DC or RMS

Note

- 1) This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2) Max. Operation Voltage : So called RCWV (Rated Continuous Working Voltage) is determined by $RCWV = \sqrt{Rated\ Power \times Resistance\ Value} \text{ or Max. RCWV listed above, whichever is lower.}$
- 3) Test condition for jumper (0 Ω)

Item	Unit	Symbol	Characteristic	Condition
Power Rating At 70°C	W		1/10	
Max. Resistance	mΩ		50	
Rated Current	А		1.0	
Peak Current	А		3.0	
Operating Temperature	°C		-55 ~+155	

NextGen Components, Inc.



THICK FILM CHIP RESISTORS CR03 SERIES

PRODUCT CHARACTERIZATION

Standard values of nominal resistance are taken from the E24 & E96 series for resistors with a tolerance Of \pm -0.1%, \pm -0.5%, \pm -1% & \pm -5%, The values of the E24/E96 series are in accordance with "IEC publication 60063"

DERATING

The power that the resistor can dissipate depends on the operating temperature; see Fig.1

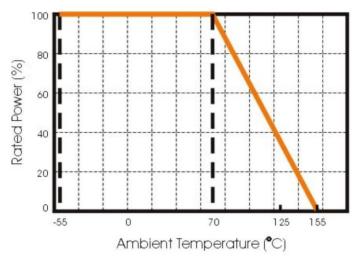


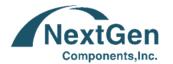
Fig 1 Maximum dissipation in percentage of rated power as a function of the ambient temperature for CR06, CR05, CR03, CR02

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems. Chip placement can be on ceramic substrates and printed-circuit boards (PCBs). Electrical connection to the circuit is by individual soldering condition. The end terminations guarantee a reliable contact.

STORAGE AND HANDLING CONDITIONS

- 1) Products are recommended to be used up within two years since operation date as ensured shelf life. Check solderability in case shelf life extension is needed.
- 2) To store products with following condition: Temperature: 5 to 40°C Humidity: 20 to 70% relative humidity
- 3) Don't store products in a corrosive environment such as sulfide, chloride gas, or acid. It may cause oxidization of electrode, which easily be resulted in poor soldering b.To store products on the shelf and avoid exposure to moisture. Don't expose products to excessive shock, vibration, direct sunlight and so on.



THICK FILM CHIP RESISTORS CR03 SERIES

REFLOW SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Resistors are tested for solderability at 235 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2.

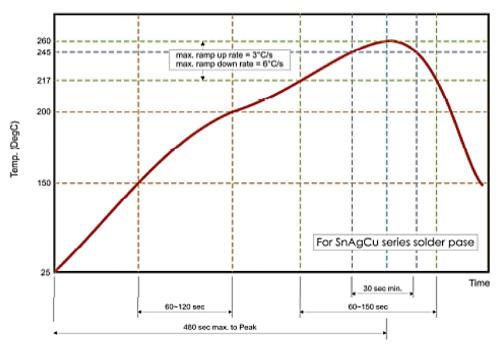


Fig 2. Infrared soldering profile for Chip Resistors

TEST AND REQUIREMENTS

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56(rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS. The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied

Temperature: $15\,^{\circ}$ C to $35\,^{\circ}$ C. Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar).

All soldering tests are performed with midly activated flux.



THICK FILM CHIP RESISTORS CR03 SERIES

TEST AND REQUIREMENT (JIS C 5201-1: 1998)

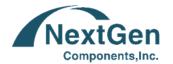
TEST	PROCEDURE / TEST METHOD	REQUIREME	NT
		Resistor	0Ω
Electrical	- DC resistance values measurement	Within the	<50mΩ
Characteristics	- Temperature Coefficient of Resistance (T.C.R)	specified tolerance	
JISC5201-1: 1998	Natural resistance change per change in degree	Refer to "QUICK	
Clause 4.8	centigrade. $\frac{R_2-R_1}{R_1(t_2-t_1)}\times 10^6 \; (\text{ppm/°C})$		
	t1 : 20°C+5°C-1°C; t2 : -55°C or +155°C		
	R1 : Resistance at reference temperature		
	(20°C+5°C/- 1°C)		
	R2: Resistance at test temperature (-55°C or +155°C)		
Resistance To	Un-mounted chips completely immersed for 10±1	±5%: ΔR/R max.	<50mΩ
Soldering Heat(R.S.H)	second in a SAC solder bath at 260°C±5°C	±(1%+0.05Ω);	
JISC5201-1:1998		±1%: ΔR/R max.	
Clause 4.18		±(0.5%+0.05Ω)	
		no visible damage	
Solderability	Un-mounted chips completely immersed for 2±0.5	95% coverage min., §	good
JISC5201-1: 1998	second in a SAC solder bath at 235°C±5°C	tinning and no visible	e damage
Clause 4.17			
Temperature cycling	30 minutes at -55°C±3°C, 2~3 minutes at 20°C+5°C-	±5%: ΔR/R max.	<50mΩ
JISC5201-1: 1998	1°C, 30 minutes at +125°C±3°C, 2~3 minutes at	±(1%+0.05Ω);	
Clause 4.19	20°C+5°C1°C, total 5 continuous cycles	±1%: ΔR/R max.	
		±(0.5%+0.05Ω)	
		no visible damage	
High Temperature	1000+48/-0 hours; without load in a temperature	±5%: ΔR/R max.	<50mΩ
Exposure	chamber controlled 155 3 C	±(2%+0.1Ω);	
MIL-STD-202		±1%: ΔR/R max.	
method 108		±(1%+0.1Ω)	
		no visible damage	



THICK FILM CHIP RESISTORS CR03 SERIES

TEST AND REQUIREMENT (JIS C 5201-1: 1998)

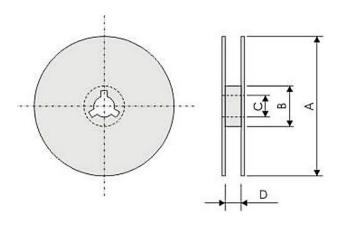
TEST	PROCEDURE / TEST METHOD	REQUIREMEN	NT
		Resistor	0Ω
Bending strength JISC5201-1: 1998 Clause 4.33	Resistors mounted on a 90mm glass epoxy resin PCB(FR4), bending once 3mm for 10sec, 5mm for CR02	\pm 5%: ΔR/R max. \pm (1%+0.05Ω); \pm 1%: ΔR/R max. \pm (1%+0.05Ω) no visible damage	<50mΩ
Adhesion JISC5201-1: 1998 Clause 4.32	Pressurizing force: 5N, Test time: 10±1sec	No remarkable damag	_
Short Time Overload (STOL) JISC5201-1: 1998 Clause 4.13	2.5 times RCWV or max. overload voltage, for 5seconds	$\pm 5\%$: ΔR/R max. $\pm (2\% + 0.05\Omega)$; $\pm 1\%$: ΔR/R max. $\pm (1\% + 0.05\Omega)$ no visible damage	<50mΩ
Load life in Humidity JISC5201-1: 1998 Clause 4.24	1000 +48/-0 hours, loaded with RCWV or Vmax in humidity chamber controller at 40 C 2 C and 90~95% relative humidity, 1.5hours on and 0.5 hours off	$\pm 5\%$: $\Delta R/R$ max. $\pm (2\% + 0.1\Omega)$; $\pm 1\%$: $\Delta R/R$ max. $\pm (1\% + 0.1\Omega)$ no visible damage	<50mΩ
Load life (endurance) JISC5201-1: 1998 Clause 4.25	1000 +48/-0 hours, loaded with RCWV or Vmax in chamber controller 70±2°C, 1.5 hours on and 0.5 Hours off	$\pm 5\%$: $\Delta R/R$ max. $\pm (3\% + 0.1\Omega)$; $\pm 1\%$: $\Delta R/R$ max. $\pm (1\% + 0.1\Omega)$ no visible damage	<50mΩ
Insulation Resistance JISC5201-1: 1998 Clause 4.6	Apply the maximum overload voltage (DC) for 1minute	R ≥ 10GΩ	
Dielectric Withstand Voltage JISC5201-1: 1998 Clause 4.7	Apply the maximum overload voltage (AC) for 1 minute	No breakdown or flas	hover 8



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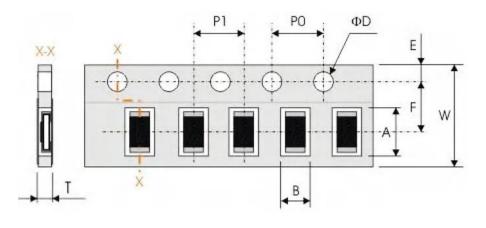
REEL DIMENSION (Unit: mm)

7": 5,000Ppcs/Reel



Code	Dimension 7"	Dimension Dimension 10"	
А	178.0+/-2.0	254.0+/-2.0	330.0+/-2.0
В	60.0 +/-1.0	100 +/-1.0	100+/-1.00
С	13.0+/-0.20	13.0+/-0.20	13.0+/-0.20
Т	9.0+/-0.50	9.0+/-0.5	9.00+/-0.50

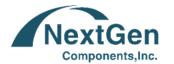
TAPE DIMENSION (Unit: mm)



Code	Dimension		
А	1.90±0.20		
В	1.10±0.20		
W	8.00±0.30		
F	3.50±0.20		
E	1.75±0.10		
P 1	4.00±0. 10		
P0	4.00±0.10		
ФD	1.50±0.10		
Т	0.65±0.05		

TAPING QUANTITY AND TAPE MATERIAL

Таре		Paper Tape						Bulk Cassette
		4 mm Pitch		2 mm Pitch			4 mm Pitch	
Reel Size	7"	10"	13"	7"	10"	13"	7"	
CR03	5000	10000	20000	10000	20000		-	20000



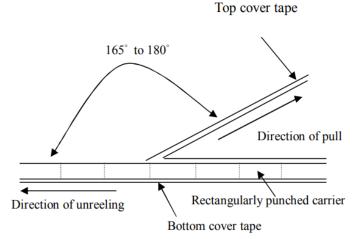
THICK FILM CHIP RESISTORS CR03 SERIES

PERFORMANCE OF TAPING

Strength of Carrier Tape and Top Cover Tape

Carrier Tape: When a tensile force 1.02kgf is applied in the direction of unreeling the tape, the tape shall withstand this force. Top cover Tape: When a tensile force 1.02kgf is applied to the tape, the tape shall withstand this force. Peel Force of Top Cover Tape

Unless otherwise specified, the peel force of top cover tape shall be 10.2 to 71.4 g f when the top cover tape is pulled at a speed of 300mm/min with the angle between the taped during peel and the direction of unreeling maintained at 165 to 180°as illustrated in Fig.



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